

SCOPE :

This specification applies to the Pb Free Signal Common mode filters
for MWCU-321619-SERIES

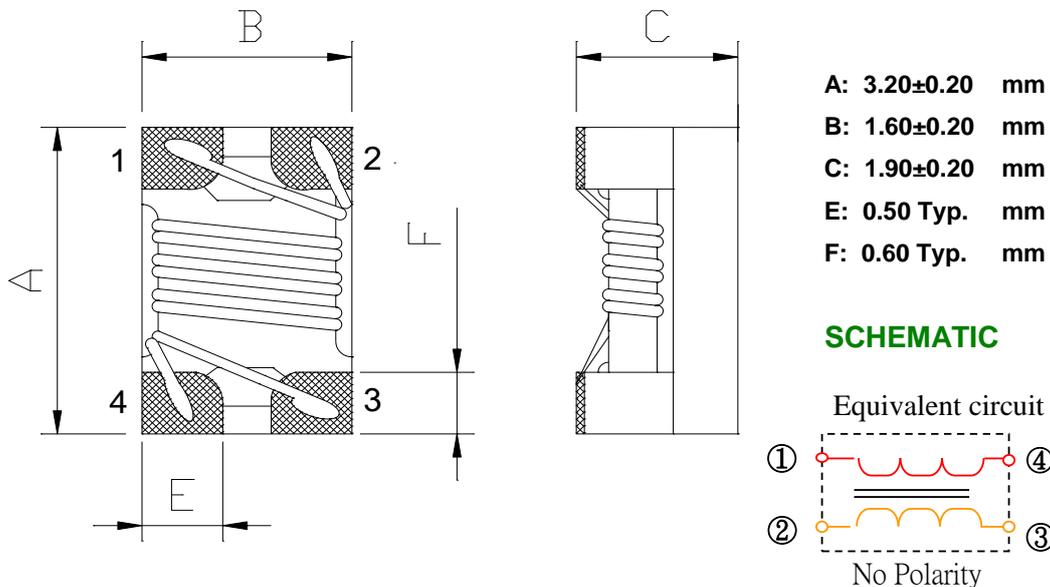
PRODUCT IDENTIFICATION

MWCU- 321619 - 900

① ② ③

- ① Product Code
- ② Dimensions Code
- ③ Inductance Code

(1) SHAPES AND DIMENSIONS



(2) ELECTRICAL SPECIFICATIONS

SEE TABLE 1

TEST INSTRUMENTS

L/Z : HP 4291B IMPEDANCE ANALYZER (or equivalent)

RDC : CHROMA MODEL 16502 MILLIOHMETER (or equivalent)

I.R : CHROMA MODEL 19073 AC/DC/IR HIPOT TESTER (or equivalent)

(3) CHARACTERISTICS

(3)-1 Operate temperature range $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$

(Including self temp. rise)

(3)-2 Storage temperature range $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$



TABLE 1

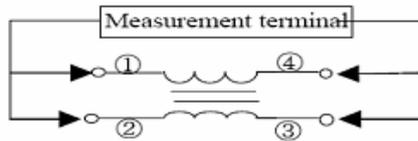
MAGLAYERS PT/NO.	Z(Ω) Impedance @100MHz	RDC (Ω) max. (1 line)	Rated Voltage Vdc(V)	Idc Max.(mA)	Withstand Voltage (V)	Insulation Resistance (M Ω)Min.
MWCU-321619-900	90 \pm 25%	0.30	50	370	125	10
MWCU-321619-121	120 \pm 25%	0.30	50	370	125	10
MWCU-321619-161	160 \pm 25%	0.40	50	340	125	10
MWCU-321619-221	220 \pm 25%	0.40	50	320	125	10
MWCU-321619-261	260 \pm 25%	0.50	50	310	125	10
MWCU-321619-601	600 \pm 25%	0.80	50	260	125	10
MWCU-321619-102	1000 \pm 25%	1.00	50	230	125	10
MWCU-321619-222	2200 \pm 25%	1.20	50	200	125	10

※ IDC : Based on temperature rise (ΔT : 40 $^{\circ}$ C Typ.)

TEST EQUIPMENT

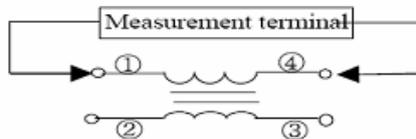
1. Impedance / Inductance

Measured by HP 4291B RF Impedance Analyzer.



2. DC Resistance

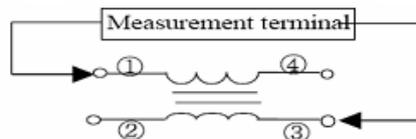
Measured by Chroma 16502 mill ohm meter



3. Insulation Resistance

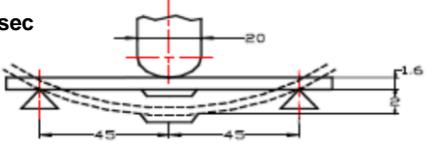
Measured by Chroma 19073

Measurement voltage: 50v, Measurement time: 3 sec.



(4) RELIABILITY TEST METHOD

Mechanical

Item	Specifications	Test conditions
Board Flex	The forces applied on the right conditions must not damage the terminal electrode and the ferrite.	Test device shall be soldered on the substrate Substrate Dimension: 100x40x1.6mm Deflection: 2.0mm Keeping Time: 60 sec 
Terminal Strength	The chip must not damage the terminal electrode and the ferrite.	Appendix 1 Note(AEC-Q200-005):Force of 1.8 kg for 60 seconds.
Solderability	The electrodes shall be at least 95% covered with new solder coating.	Pre-heating: 150°C, 1min Solder Composition: Sn/3.0Ag/0.5Cu Solder Temperature: 245±5°C Immersion Time: 4±1sec
Resistance to Soldering Heat	Appearance:No damage Inductance change shall be within ±20%.	Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0.5 Solder Temperature: 260±5°C Immersion Time: 10±1sec
Resistance to Solvents	There must be no change in appearance or obliteration of marking.	Inductors must withstand 6 minutes of alcohol or water.
Mechanical Shock	The forces applied on the right conditions must not damage the terminal electrode and the ferrite.	Pulse shape : Half-sine waveform Impact acceleration : 100 g Pulse duration : 6 ms Number of shocks : 18 shocks (3 shocks for each face) Orientation : Bottom, top, left, right, front and rear faces
Vibration	Appearance:No damage Inductance change shall be within ±20%.	Vibration waveform: Sine waveform Vibration frequency: 10Hz~2000Hz Vibration acceleration: 5g Sweep rate: 0.764386octave/minute Duration of test: 12 cycles each of 3 orientations 20 minutes for each cycle Vibration axes: X, Y & Z



(4) RELIABILITY TEST METHOD

Environmental

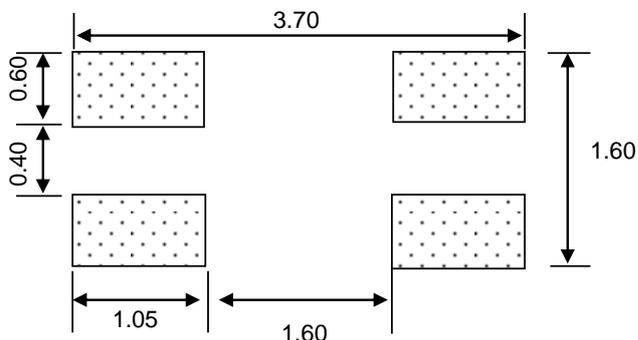
Item	Specifications	Test conditions
High Temperature Exposure (Storage)	Appearance: No damage (for microscope of CASTOR MZ-420X) Inductance change shall be within $\pm 20\%$.	Temperature: $125 \pm 3^\circ\text{C}$ Time: 100hrs Measured after exposure in the room condition for 24hrs
Operational Life		Temperature: $125 \pm 2^\circ\text{C}$ Applied Current : Rated Current Time: 100 ± 24 hrs Measured after exposure in the room condition for 24hrs
Biased Humidity		Temperature: $85 \pm 2^\circ\text{C}$ Relative Humidity: 85% Time: 100hrs Measured after exposure in the room condition for 24hrs
Temperature Cycling		Total cycles: 100 cycles Temperature Cycling Test Conditions : -40 to $+125^\circ\text{C}$ Soak Mode Condition : 30 minutes Measured after exposure in the room condition for 24hrs

(5) RECOMMENDED SOLDERING CONDITIONS

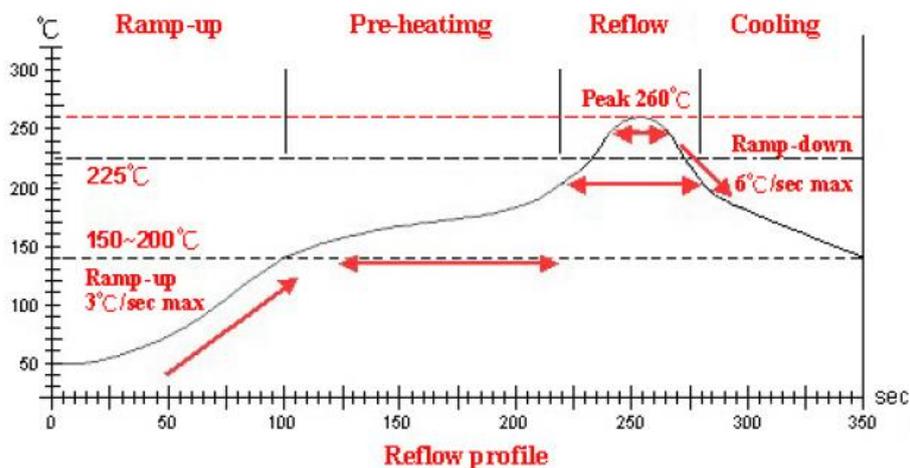
(Please use this product by reflow soldering)

(5)-1 RECOMMENDED FOOTPRINT

Unit: mm



(5)-2 RECOMMENDED REFLOW PATTERN



Lead-Free(LF)

Refer to J-STD-020C

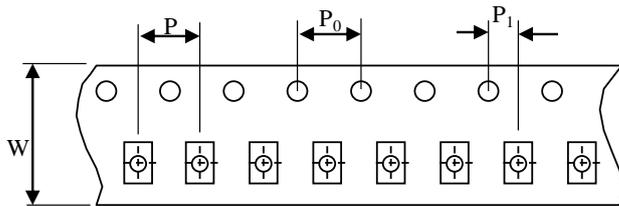
Item	Ramp-up	Pre-heating	Reflow	Peak Temp.	Cooling
Temp. scope	R.T.~150°C	150°C~200°C	225°C	260±5°C	Peak Temp.~150°C
Time result	—	60~180 Sec.	20~60 Sec.	5~10 Sec.	—

NOTE:

1. Re-flow possible times:with in 2 times
2. Nitrogen adopted is recommended while in re-flow

(6) PACKAGING

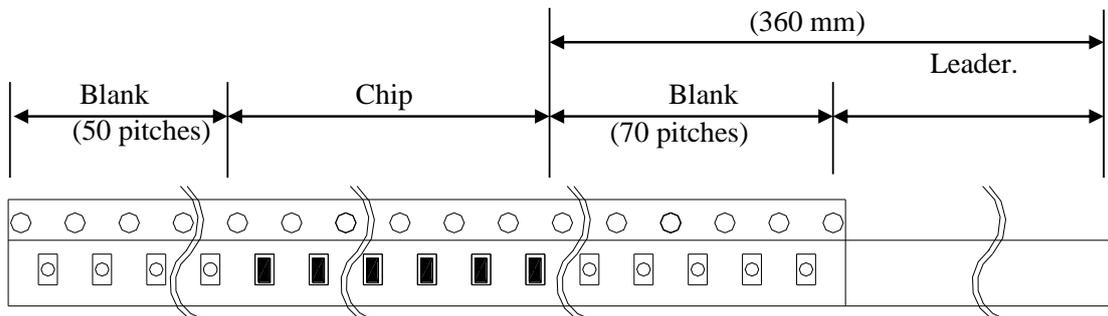
(6)-1 CARRIER TAPE DIMENSIONS (mm)



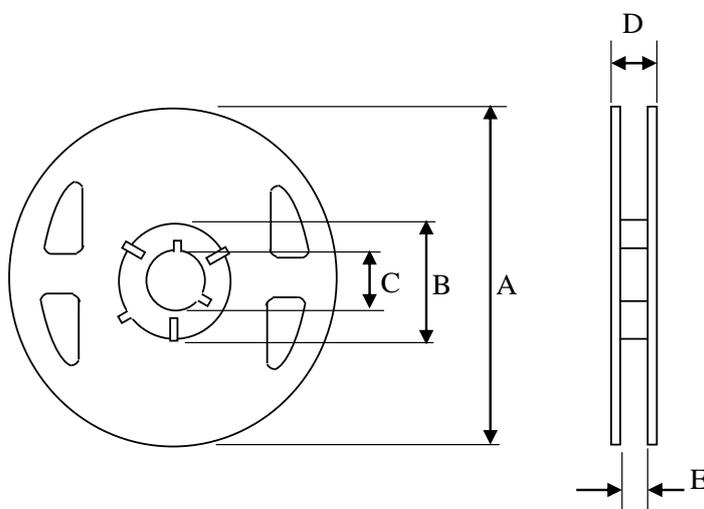
$W : 8.0 \text{ mm}$
 $P : 4.0 \text{ mm}$
 $P_0 : 4.0 \text{ mm}$
 $P_1 : 2.0 \text{ mm}$

(6)-2 TAPING DIMENSIONS (mm)

There shall not continuation more than two vacancies of the product.



(6)-3 REEL DIMENSIONS



$A : 180 \text{ mm}$
 $B : 60 \text{ mm}$
 $C : 13.5 \text{ mm}$
 $D : 15.5 \text{ mm}$
 $E : 9.0 \text{ mm}$

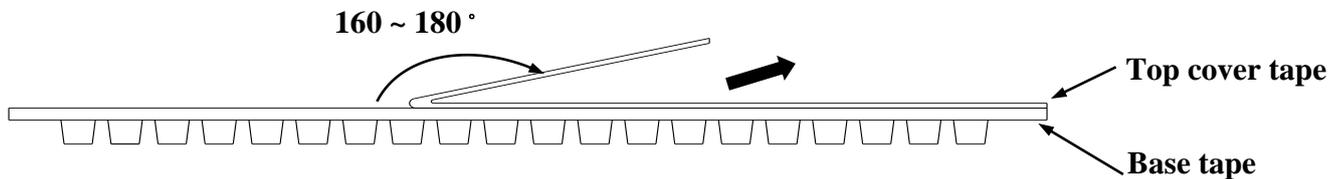
(6)-4 COVER TAPE PEEL STRENGTH

The force for tearing off cover tape is 0.1~0.6(N) in the arrow direction at the following conditions:

Temperature : 5 ~ 35°C

Humidity : 45 ~ 85%

Atmospheric pressure : 860 ~ 1060 hpa



(6)-5 QUANTITY

2000 pcs/Reel

(6)-6 The products are packaged so that no damage will be sustained.

(7) ATTENTION IN CASE OF USING

In case of using product ,please avoid following matters:

Splashing water or salt water

Dew condensens

Toxic gas (Hydrogen sulfide, Sulfurous acid ,Chlorine, Ammonia)

Vibrations or shocks which exceed the specified condition

Please be careful for the stress to this product by board flexure or something after the mounting.

Please note that the contents may change without any prior notice due to reasons such as upgrading.